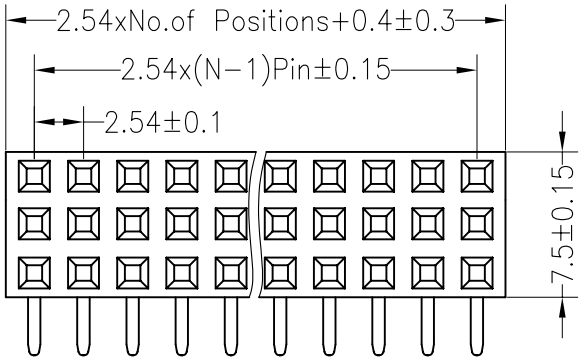
HSF RoHS

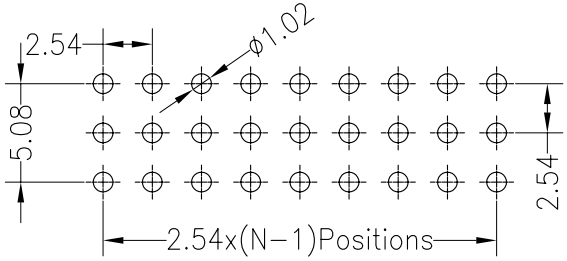
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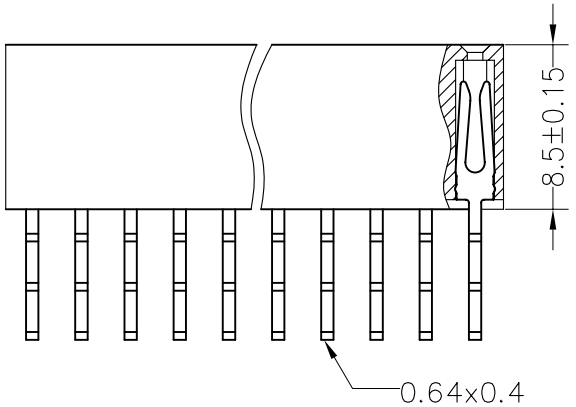
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

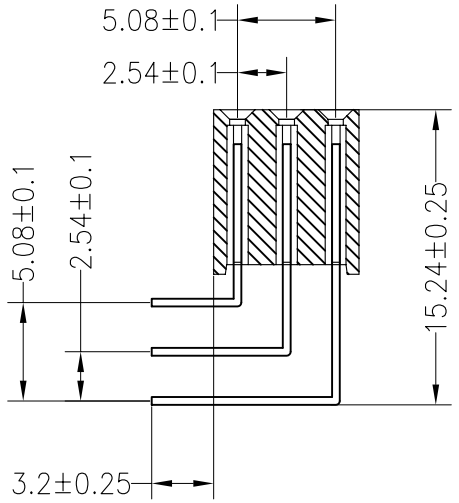
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







Ordering Information

2285 03 XX X N XX R Y X 01

- No.of Pins Per Row: 3*40
- Insulator Material Option: A=BK−PBT; B=BK−PA66; C=BK−PA6T; D=BK−PA46; F=BK−LCP
- Contact Plating: G0:Gold Flash; G2:5U" Gold; G3:10U" Gold; G4:15U" Gold; G5:30U" Gold; S0:Gold Flash/Tin; SN:Tin
- Packing: 0=PE Bag; A=Tray; T=Tube; P=Tube+Cap

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	12.03.28
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	228503XXXNXXRYX01
TITLE:	2.54PF H8.5mm 3xNpin 90°